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MCCOG42005A6W-BNMLWI-\	4 x 20			LCD Module				
Specification								
Version: 1				Date: 28/09/202	22			
	Revision							
1 27/09	9/2022	First Iss	sue					

Display F	eatures		
Character Count	4 x 20		
Appearance	White on Blue		
Logic Voltage	3V		
Interface	l <sup>2</sup> C		
Font Set	N/A		oHS ompliant
Character Height	4.67mm		mpliant
Display Mode	Transmissive		mphant
LC Туре	Blue STN		
Module Size	74.30 x 36.40 x 6.00mm		
Operating Temperature	-20°C ~ +70°C	Box Quantity	Weight / Display
Construction	COG		
LED Backlight	White		
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\* - For full design functionality, please use this specification in conjunction with the IST3602 specification. (Provided Separately)

Disp	Display Accessories						
Part Number Description							

Optional Variants				
Voltage				

#### **General Specification**

The Features is described as follow:

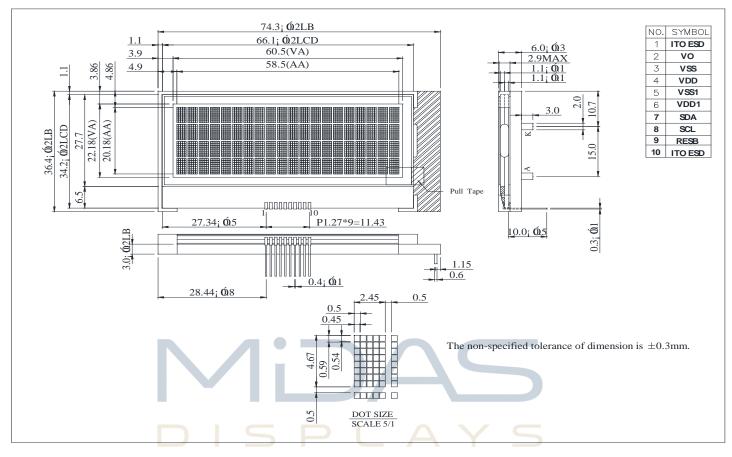
- Module dimension: 74.3 x 36.4 x 6.0 mm
- View area: 60.5 x 22.18 mm
- Active area: 58.5 x 20.18 mm
- Dot size: 0.45x 0.54 mm
- Dot pitch: 0.50 x 0.59 mm
- Character size: 2.45 x 4.67 mm
- Character pitch: 2.95 x 5.17 mm
- LCD type: STN Negative, Blue Transmissive
- Duty: 1/33DUTY,1/6BIAS
- View direction: 6 o'clock
- Backlight Type: LED, White
- IC: IST3602
- Interface: I2C DESIGN • MANUFACTURE • SUPPLY

#### **Interface Pin Function**

Pin	Symbol	Function Description
1	ITO ESD	Ground
2	V0	LCD Power Supply
3	VSS	Ground(VSS2&VSS3)
4	VDD	Power Supply(VDD2&VDD3)
5	VSS1	Ground(VSS1)
6	VDD1	Power Supply(VDD1)
7	SDA	Serial input data
8	SCL	Serial input clock
9	RESB	Hardware Reset input pin
10	ITO ESD	Ground

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## **Contour Drawing**



#### 1. Initial code

void Initial(void)

{

RST = 1;MANUFACTURE • SUPPLY delay\_ms(10); RST = 0;delay\_ms(10); RST = 1;delay\_ms(10); //i2c\_start Start(); Write byte(0x78); // salve address \_\_\_\_\_ // IS Instruction Table 0 WriteIns(0x20); //Function Set WriteIns(0x01); //Clear Display delay\_ms(20); //Set DDRAM address WriteIns(0x90); WriteIns(0x00); //Set DDRAM address WriteIns(0x06); //Set Entry Mode WriteIns(0x0C); //Display Control // === // IS Instruction Table 1 //Function Set : 0 0 1 0 0 0 IS2 IS1 WriteIns(0x21);

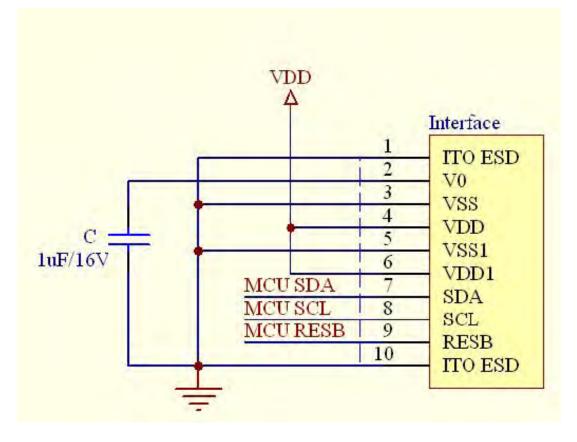
//	WriteIns(0x12); WriteIns(0x40); WriteIns(0x30); WriteIns(0x6F); WriteIns(0x70); delay_ms(100);	<pre>//Follows Control :0 0 0 1 0 0 BS2 BS1 Bias select:1/6B //Set ICON RAM Address //Power Control 1 :0 0 1 1 0 0 0 SLEEP //ICON/Power Control2 //Set booster ;V0 Control 2</pre>
// =	// IS Instruction Ta WriteIns(0x23); WriteIns(0x81); WriteIns(0x27);	able 3 //Function Set :001000IS2IS1 //Contrast: VOP SET // VOP SET
	WriteIns(0x82); WriteIns(0x00);	//start line setting //start line setting :0 0 ST[5:0]
11	WriteIns(0xA7);	//Rgain set :1 0 1 0 RR[3:0]
// =	// IS Instruction Ta WriteIns(0x22); WriteIns(0x60); WriteIns(0x13); WriteIns(0x44);	able 2 //Function Set : 0 0 1 0 0 0 IS2 IS1 //Set Display pattern : 0 1 1 0 0 0 INV AP //Set Display Mode :0 0 0 1 DH1 DH0 N2 N1 1/33D //Select CGRAM & COM/SEG direction
//	// IS Instruction Ta WriteIns(0x23); WriteIns(0x88); WriteIns(0x88); WriteIns(0x88); WriteIns(0x88);	able 3 //Function Set : 0 0 1 0 0 0 IS2 IS1 // Set 88H 4 times to entry IST test command mode
	WriteIns(0x28);	N //Frame rate adjusting enable RE • SUPPLY
	WriteIns(0xB2); WriteIns(0xEF); WriteIns(0x00);	//1st Frame rate control //2nd LN[7:0] //3rd LN[15:8] 95Hz
	WriteIns(0x93); WriteIns(0x99);	//OSC Clock Select :Fosc/1 //OSC Divide Select :750KHz
// =	WriteIns(0xE3);	//Exit IST test command
}	 Stop();	//i2c_stop

#### \*NOTE:

This Initial code is a suggested value, and customers can change the parameters according to a ctual needs.

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#### 2. APPLICATION EXAMPLES



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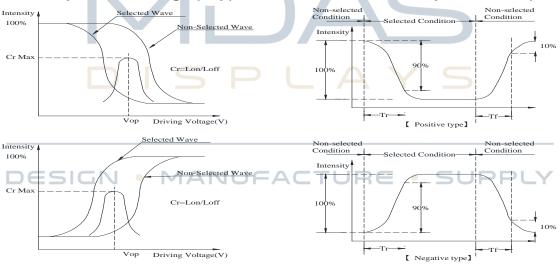
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### **Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR≧2	0	_	20	ψ= 180°
	θ	CR≧2	0	_	40	ψ= 0°
View Angle	θ	CR≧2	0	—	30	ψ= 90°
	θ	CR≧2	0	_	30	ψ= 270°
Contrast Ratio	CR	_		3		_
Response Time	T rise	_		150	200	ms
	T fall			150	200	ms

#### Definition of Operation Voltage (Vop)

Definition of Response Time (Tr, Tf)

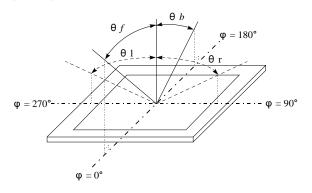


**Conditions :** 

Operating Voltage : Vop

Viewing Angle( $\theta$ ,  $\phi$ ) : 0°, 0°

Frame Frequency : 64 HZ Driving Waveform : 1/N duty , 1/a bias **Definition of viewing angle(CR≧2)** 



#### **Absolute Maximum Ratings**

ltem	Symbol	Min	Тур	Мах	Unit
Operating Temperature	ТОР	-20	_	+70	°C
Storage Temperature	TST	-30	_	+80	°C
Input Voltage	VIN	-0.3	_	V <sub>DD</sub> +0.3	V
Power Supply Voltage	Vdd	-0.3	_	4.0	V
LCD Driver Voltage	VLCD	-0.3	_	18.0	V

#### **Electrical Characteristics**

Item Symbo		Condition	Min	Тур	Max	Unit
Supply Voltage For	Vdd	_	2.7	3.0	3.3	V
Logic						
DESIGN	MAN	UTa=-20℃ T	URE	•N	UPPL	V
Supply Voltage For LCD	Vo-Vss	Ta=25°C	7.6	7.8	8.0	V
		Ta=70°C	_			V
Input High Volt.	Vін	_	0.8 Vddio	_	Vdd	V
Input Low Volt.	VIL	_	Vss		$0.2 V_{DD}$	V
Output High Volt.	V <sub>он</sub>	_	0.8 V <sub>DDIO</sub>	_	V <sub>DD</sub>	V
Output Low Volt.	V <sub>OL</sub>		_		0.2 V <sub>DD</sub>	V
Supply LCM current	IDD	VDD=3.0V	_	0.5	_	mA

Please kindly consider to design the Vop to be adjustable while programing the software to match LCD contrast tolerance.

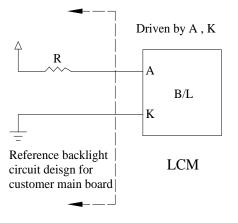
## **Backlight Information**

#### Specification

PARAMETER	SYMBOL	MIN	ТҮР	МАХ	UNIT	TEST CONDITION
Supply Current	ILED	15	48	60	mA	
Supply Voltage	V	_	3.5	_	v	
Reverse Voltage	VR	_	_	5	v	
Chromaticity	х	0.25	0.28	0.31	_	V=3.5V
Coordinates	Y	0.25	0.28	0.31	_	
Luminance	IV	728	910		CD/M <sup>2</sup>	
(Without LCD)		720	510			
LED Life Time		1.5				ILED=48mA
(For Reference		S	50K	_ /	Hr. Y	25°C,50-60%RH,
only)						(Note 1)
Color	White		UFA	сти	RE	• SUPPLY

Note: The LED of B/L is drive by current only, drive voltage is for reference only. drive voltage can make driving current under safety area (current between minimum and maximum).

Note 1:50K hours is only an estimate for reference.



## Reliability

#### Content of Reliability Test (Wide temperature, -20℃~70℃)

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30°C 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70°C 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20°C 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60°C,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60°C,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20°C 25°C 70°C 30min 5min 30min 1 cycle	-20°C/70°C 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude : 1.5mm Vibration Frequency : 10~55Hz One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=±600V(contact), ±800v(air), RS=330 Ω CS=150pF 10 times	

Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal

Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

## Inspection specification

NO	Item			Criterion		AQL
01	Electrical Testing	<ol> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ol>				
02	Black or white spots on LCD (display only)	<ul> <li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li> <li>2.2 Densely spaced: No more than two spots or lines within 3mm</li> </ul>				
03	LCD black spots, white spots, contamination		Φ=(x + y)/2 $SIZE Acceptable Q TY$ $Φ ≤ 0.10 Accept no dense$ $0.10 < Φ ≤ 0.20 2$ $0.20 < Φ ≤ 0.25 1$ $0.25 < Φ 0$ $X + Y Y = Y$ $T = Y$ $T = Y$			
	(non-display)	3.2 Line type : (,	As followin Length  L≦3.0 L≦2.5 	ng drawing) Width W≦0.02 0.02 <w≦0.03 0.03<w≦0.05 0.05<w< td=""><td>Acceptable Q TY Accept no dense 2 As round type</td><td>2.5</td></w<></w≦0.05 </w≦0.03 	Acceptable Q TY Accept no dense 2 As round type	2.5

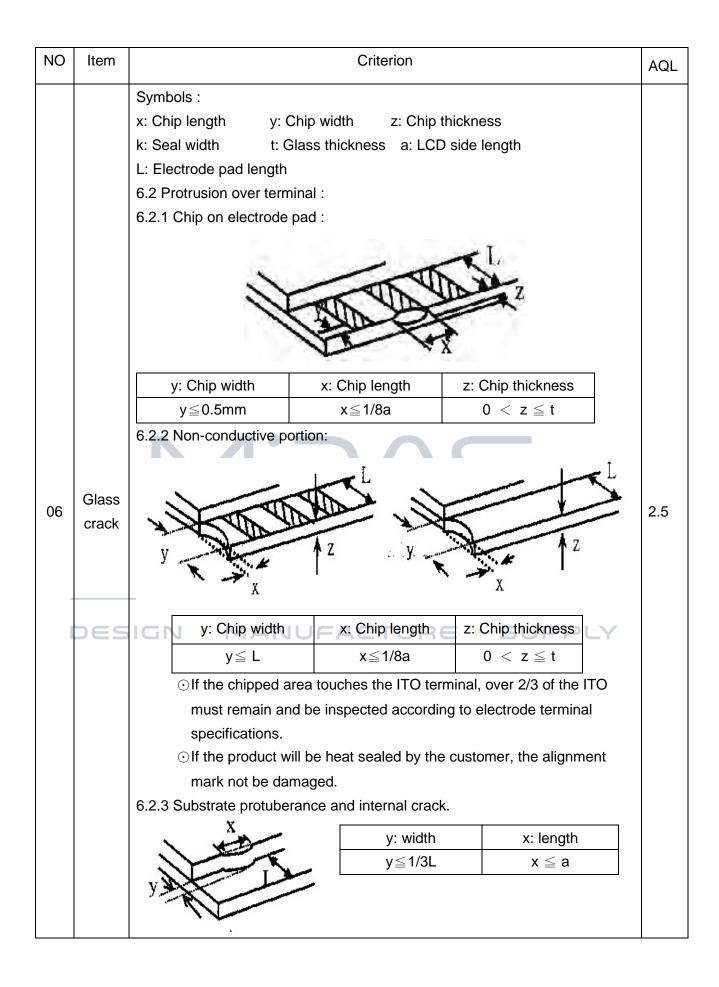
04	Polarizer bubbles	If bubbles are visible, judge using black spot specifications, not easy to find, must check in specify direction.	Size $\Phi$ $\Phi \le 0.20$ $0.20 < \Phi \le 0.50$ $0.50 < \Phi \le 1.00$ $1.00 < \Phi$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 0 3	2.5
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# Midas DISPLAYS

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NO	Item	Criterion				
05	Scratches	Follow NO.3 LCD black spots, white spots, contamination				
06	Chipped glass	Symbols Define: x: Chip length y: 0 k: Seal width t: 0 L: Electrode pad length 6.1 General glass chip 6.1.1 Chip on panel sur $\begin{array}{c} \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\ \\$	Chip width z: Chip t Glass thickness a: LCD :	thickness b side length panels: x: Chip length $x \le 1/8a$ $x \le 1/8a$	2.5	
		z: Chip thickness	y: Chip width	x: Chip length		
		Z≦1/2t	Not over viewing area	x≦1/8a		
		$1/2t < z \leq 2t$	Not exceed 1/3k	x≦1/8a		
		$\odot$ If there are 2 or more	chips, x is the total leng	of each chip.		



NO	Item	Criterion	AQL	
07	Cracked glass	The LCD with extensive crack is not acceptable.		
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged. Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65	
09	Bezel	<ul> <li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li> <li>9.2 Bezel must comply with job specifications.</li> </ul>	2.5 0.65	
		<ul><li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li><li>10.2 COB seal surface may not have pinholes through to the</li></ul>	2.5	
		IC. 10.3 The height of the COB should not exceed the height	2.5 0.65	
		indicated in the assembly diagram. 10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than	2.5	
10	PCB · COB	<ul> <li>three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> </ul>	2.5 0.65	
0	DESIGN	10.7 The jumper on the PCB should conform to the product characteristic chart.	0.65	
		10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.	2.5	
		10.9 The Scraping testing standard for Copper Coating of PCB	2.5	
11	Soldering	<ul><li>11.1 No un-melted solder paste may be present on the PCB.</li><li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li></ul>	2.5 2.5	
		<ul><li>11.3 No residue or solder balls on PCB.</li><li>11.4 No short circuits in components on PCB.</li></ul>	2.5 0.65	

NO	Item	Criterion	AQL
NO 12	Item General appearance	Criterion 12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP. 12.2 No cracks on interface pin (OLB) of TCP. 12.3 No contamination, solder residue or solder balls on product. 12.4 The IC on the TCP may not be damaged, circuits. 12.5 The uppermost edge of the protective strip on the interface pin must be present or look as if it cause the interface pin to sever. 12.6 The residual rosin or tin oil of soldering (component or chip component) is not burned into brown or black color. 12.7 Sealant on top of the ITO circuit has not hardened. 12.8 Pin type must match type in specification sheet.	AQL 2.5 0.65 2.5 2.5 2.5 2.5 2.5 2.5 0.65 0.65
		12.8 Pin type must match type in specification sheet. 12.9 LCD pin loose or missing pins.	0.65 0.65
		<ul> <li>12.10 Product packaging must the same as specified on packaging specification sheet.</li> <li>12.11 Product dimension and structure must conform to product specification sheet.</li> <li>12.12 Visual defect outside of VA is not considered to be</li> </ul>	0.65
		rejection.	

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#### **Precautions in use of LCD Modules**

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6)Soldering: only to the I/O terminals.
- (7)Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors,capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)
- (10) To ensure the stability of the display screen, please apply screen saver after showing 30 mins of fixed display content.
- (11)Please heat up a little the tape sticking on the components when removing it; otherwise the components might be damaged.

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## **Material List of Components for RoHs**

1.Midas Displays hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A : The Harmful Material List

Material	Cd	Pb	Hg	Cr6+	PBB	PBDE	DEHP	BBP	DBP	DIBP
Limited	100	1000	1000	1000	1000	1000	1000	1000	1000	1000
Value ppm ppm ppm ppm ppm ppm ppm ppm ppm pp										ppm
Above limited value is set up according to RoHS.										

2. Process for RoHS requirement : (only for RoHS inspection)

- (1) Use the Sn/Ag/Cu soldering surface ; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

Reflow : 250°C,30 seconds Max. ;

Connector soldering wave or hand soldering : 320°C, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5°C ;

Recommended customer's soldering temp. of connector : 280°C, 3 seconds.

#### **Recommendable Storage**

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.